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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	6
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	8-VDFN Exposed Pad
Supplier Device Package	8-QFN (5x6)
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0213qb005sg

On-Chip Debugger

F0823 Series products feature an integrated On-Chip Debugger. The OCD provides a rich-set of debugging capabilities, such as reading and writing registers, programming Flash memory, setting breakpoints and executing code. A single-pin interface provides communication to the OCD.

Table 3. Signal Descriptions (Continued)

Signal Mnemonic	I/O	Description
COUT	O	Comparator Output. This is the output of the comparator.
Analog		
ANA[7:0]	I	Analog port. These signals are used as inputs to the ADC. The ANA0, ANA1, and ANA2 pins can also access the inputs and output of the integrated transimpedance amplifier.
VREF	I/O	Analog-to-Digital Converter reference voltage input.
Clock Input		
CLKIN	I	Clock Input Signal. This pin can be used to input a TTL-level signal to be used as the system clock.
LED Drivers		
LED	O	Direct LED drive capability. All port C pins have the capability to drive an LED without any other external components. These pins have programmable drive strengths set by the GPIO block.
On-Chip Debugger		
DBG	I/O	Debug. This signal is the control and data input and output to and from the OCD. Caution: The DBG pin is open-drain and requires an external pull-up resistor to ensure proper operation.
Reset		
RESET	I/O	RESET. Generates a reset when asserted (driven Low). Also serves as a reset indicator; the Z8 Encore! XP forces this pin Low when in reset. This pin is open-drain and features an enabled internal pull-up resistor.
Power Supply		
V _{DD}	I	Digital Power Supply.
AV _{DD} ²	I	Analog Power Supply.
V _{SS}	I	Digital Ground.
AV _{SS}	I	Analog Ground.

Notes:

1. PB6 and PB7 are only available in 28-pin packages without ADC. In 28-pin packages with ADC, they are replaced by AV_{DD} and AV_{SS}.
2. The AV_{DD} and AV_{SS} signals are available only in 28-pin packages with ADC. They are replaced by PB6 and PB7 on 28-pin packages without ADC.

returns FFH. Writing to these unimplemented Program Memory addresses produces no effect. Table 6 describes the Program Memory maps for the Z8 Encore! XP F0823 Series products.

Table 6. Z8 Encore! XP F0823 Series Program Memory Maps

Program Memory Address (Hex)	Function
Z8F0823 and Z8F0813 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–0005	WDT Interrupt Vector
0006–0007	Illegal Instruction Trap
0008–0037	Interrupt Vectors*
0038–003D	Oscillator Fail Traps*
003E–0FFF	Program Memory
Z8F0423 and Z8F0413 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–0005	WDT Interrupt Vector
0006–0007	Illegal Instruction Trap
0008–0037	Interrupt Vectors*
0038–003D	Oscillator Fail Traps*
003E–0FFF	Program Memory
Z8F0223 and Z8F0213 Products	
0000–0001	Flash Option Bits
0002–0003	Reset Vector
0004–0005	WDT Interrupt Vector
0006–0007	Illegal Instruction Trap
0008–0037	Interrupt Vectors*
0038–003D	Oscillator Fail Traps*
003E–07FF	Program Memory

Note: *See the [Trap and Interrupt Vectors in Order of Priority](#) section on page 55 for a list of the interrupt vectors and traps.

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
LED Controller (cont'd)				
F84	LED Drive Level Low Byte	LEDLVLL	00	<u>53</u>
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator Control	OSCCTL	A0	<u>172</u>
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 Control	CMP0	14	<u>133</u>
F91–FBF	Reserved	—	XX	
Interrupt Controller				
FC0	Interrupt Request 0	IRQ0	00	<u>59</u>
FC1	IRQ0 Enable High Bit	IRQ0ENH	00	<u>62</u>
FC2	IRQ0 Enable Low Bit	IRQ0ENL	00	<u>62</u>
FC3	Interrupt Request 1	IRQ1	00	<u>60</u>
FC4	IRQ1 Enable High Bit	IRQ1ENH	00	<u>64</u>
FC5	IRQ1 Enable Low Bit	IRQ1ENL	00	<u>64</u>
FC6	Interrupt Request 2	IRQ2	00	<u>61</u>
FC7	IRQ2 Enable High Bit	IRQ2ENH	00	<u>65</u>
FC8	IRQ2 Enable Low Bit	IRQ2ENL	00	<u>66</u>
FC9–FCC	Reserved	—	XX	
FCD	Interrupt Edge Select	IRQES	00	<u>67</u>
FCE	Shared Interrupt Select	IRQSS	00	<u>67</u>
FCF	Interrupt Control	IRQCTL	00	<u>68</u>
GPIO Port A				
FD0	Port A Address	PAADDR	00	<u>40</u>
FD1	Port A Control	PACTL	00	<u>42</u>
FD2	Port A Input Data	PAIN	XX	<u>43</u>
FD3	Port A Output Data	PAOUT	00	<u>43</u>
GPIO Port B				
FD4	Port B Address	PBADDR	00	<u>40</u>
FD5	Port B Control	PBCTL	00	<u>42</u>

Note: XX=Undefined.

General-Purpose Input/Output

Z8 Encore! XP F0823 Series products support a maximum of 24 port pins (Ports A–C) for general-purpose input/output (GPIO) operations. Each port contains control and data registers. The GPIO control registers determine data direction, open-drain, output drive current, programmable pull-ups, Stop Mode Recovery functionality, and alternate pin functions. Each port pin is individually programmable. In addition, the Port C pins are capable of direct LED drive at programmable drive strengths.

GPIO Port Availability By Device

Table 15 lists the port pins available with each device and package type.

Table 15. Port Availability by Device and Package Type

Devices	Package	10-Bit ADC	Port A	Port B	Port C	Total I/O
Z8F0823SB, Z8F0823PB Z8F0423SB, Z8F0423PB Z8F0223SB, Z8F0223PB Z8F0123SB, Z8F0123PB	8-pin	Yes	[5:0]	No	No	6
Z8F0813SB, Z8F0813PB Z8F0413SB, Z8F0413PB Z8F0213SB, Z8F0213PB Z8F0113SB, Z8F011vPB	8-pin	No	[5:0]	No	No	6
Z8F0823PH, Z8F0823HH Z8F0423PH, Z8F0423HH Z8F0223PH, Z8F0223HH Z8F0123PH, Z8F0123HH	20-pin	Yes	[7:0]	[3:0]	[3:0]	16
Z8F0813PH, Z8F0813HH Z8F0413PH, Z8F0413HH Z8F0213PH, Z8F0213HH Z8F0113PH, Z8F0113HH	20-pin	No	[7:0]	[3:0]	[3:0]	16
Z8F0823PJ, Z8F0823SJ Z8F0423PJ, Z8F0423SJ Z8F0223PJ, Z8F0223SJ Z8F0123PJ, Z8F0123SJ	28-pin	Yes	[7:0]	[5:0]	[7:0]	22
Z8F0813PJ, Z8F0813SJ Z8F0413PJ, Z8F0413SJ Z8F0213PJ, Z8F0213SJ Z8F0113PJ, Z8F0113SJ	28-pin	No	[7:0]	[7:0]	[7:0]	24

- Execution of an Return from Interrupt (IRET) instruction
- Writing a 1 to the IRQE bit in the Interrupt Control Register

Interrupts are globally disabled by any of the following actions:

- Execution of a Disable Interrupt (DI) instruction
- eZ8 CPU acknowledgement of an interrupt service request from the interrupt controller
- Writing a 0 to the IRQE bit in the Interrupt Control Register
- Reset
- Execution of a Trap instruction
- Illegal Instruction Trap
- Primary Oscillator Fail Trap
- Watchdog Timer Oscillator Fail Trap

Interrupt Vectors and Priority

The interrupt controller supports three levels of interrupt priority. Level 3 is the highest priority, Level 2 is the second highest priority, and Level 1 is the lowest priority. If all interrupts are enabled with identical interrupt priority (for example, all as Level 2 interrupts), the interrupt priority is assigned from highest to lowest as specified in [Table 35](#) on page 55. Level 3 interrupts are always assigned higher priority than Level 2 interrupts which, in turn, always are assigned higher priority than Level 1 interrupts. Within each interrupt priority level (Level 1, Level 2 or Level 3), priority is assigned as specified in [Table 35](#). Reset, Watchdog Timer interrupt (if enabled), Primary Oscillator Fail Trap, Watchdog Timer Oscillator Fail Trap, and Illegal Instruction Trap always have highest (Level 3) priority.

Interrupt Assertion

Interrupt sources assert their interrupt requests for only a single system clock period (single pulse). When the interrupt request is acknowledged by the eZ8 CPU, the corresponding bit in the Interrupt Request register is cleared until the next interrupt occurs. Writing a 0 to the corresponding bit in the Interrupt Request register likewise clears the interrupt request.

! **Caution:** Zilog recommends not using a coding style that clears bits in the Interrupt Request registers. All incoming interrupts received between execution of the first LDX command and the final LDX command are lost. See Example 1, which follows.

$$\text{PWM Period (s)} = \frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than 0001H is loaded into the Timer High and Low Byte registers, use the ONE-SHOT Mode equation to determine the first PWM time-out period. If TPOL is set to 0, the ratio of the PWM output High time to the total period is represented by the following equation:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$$

If TPOL is set to 1, the ratio of the PWM output High time to the total period is represented by the following equation:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{PWM Value}}{\text{Reload Value}} \times 100$$

PWM Dual Output Mode

In PWM DUAL OUTPUT Mode, the timer outputs a PWM output signal pair (basic PWM signal and its complement) through two GPIO port pins. The timer input is the system clock. The timer first counts up to the 16-bit PWM match value stored in the Timer PWM High and Low Byte registers. When the timer count value matches the PWM value, the Timer Output toggles. The timer continues counting until it reaches the reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes.

If the TPOL bit in the Timer Control Register is set to 1, the Timer Output signal begins as a High (1) and transitions to a Low (0) when the timer value matches the PWM value. The Timer Output signal returns to a High (1) after the timer reaches the reload value and is reset to 0001H.

If the TPOL bit in the Timer Control Register is set to 0, the Timer Output signal begins as a Low (0) and transitions to a High (1) when the timer value matches the PWM value. The Timer Output signal returns to a Low (0) after the timer reaches the reload value and is reset to 0001H.

The timer also generates a second PWM output signal Timer Output Complement. The Timer Output Complement is the complement of the Timer Output PWM signal. A programmable deadband delay can be configured to time delay (0 to 128 system clock cycles) PWM output transitions on these two pins from a low to a high (inactive to active). This ensures a time gap between the deassertion of one PWM output to the assertion of its complement.

4. Clear the Timer PWM High and Low Byte registers to 0000H. Clearing these registers allows the software to determine if interrupts were generated by either a capture or a reload event. If the PWM High and Low Byte registers still contain 0000H after the interrupt, the interrupt was generated by a reload.
5. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting TICONFIG field of the TxCTL1 Register.
6. Configure the associated GPIO port pin for the Timer Input alternate function.
7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time from timer start to capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

COMPARE Mode

In COMPARE Mode, the timer counts up to the 16-bit maximum compare value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the compare value, the timer generates an interrupt and counting continues (the timer value is not reset to 0001H). Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) upon compare.

If the Timer reaches FFFFH, the timer rolls over to 0000H and continue counting. Observe the following steps to configure a timer for COMPARE Mode and to initiate the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for COMPARE Mode
 - Set the prescale value
 - Set the initial logic level (High or Low) for the Timer Output alternate function, if appropriate
2. Write to the Timer High and Low Byte registers to set the starting count value.
3. Write to the Timer Reload High and Low Byte registers to set the compare value.
4. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers.

5. Configure the associated GPIO port pin for the Timer Input alternate function.
6. Write to the Timer Control Register to enable the timer.
7. Assert the Timer Input signal to initiate the counting.

CAPTURE/COMPARE Mode

In CAPTURE/COMPARE Mode, the timer begins counting on the first external Timer Input transition. The acceptable transition (rising edge or falling edge) is set by the TPOL bit in the Timer Control Register. The timer input is the system clock.

Every subsequent acceptable transition (after the first) of the Timer Input signal captures the current count value. The capture value is written to the Timer PWM High and Low Byte registers. When the capture event occurs, an interrupt is generated, the count value in the Timer High and Low Byte registers is reset to 0001H, and counting resumes. The INPCAP bit in TxCTL1 Register is set to indicate the timer interrupt is caused by an input capture event.

If no capture event occurs, the timer counts up to the 16-bit compare value stored in the Timer Reload High and Low Byte registers. Upon reaching the compare value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. The INPCAP bit in TxCTL1 Register is cleared to indicate the timer interrupt is not because of an input capture event.

Observe the following steps to configure a timer for CAPTURE/COMPARE Mode and initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for CAPTURE/COMPARE Mode
 - Set the prescale value
 - Set the capture edge (rising or falling) for the Timer Input
2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H).
3. Write to the Timer Reload High and Low Byte registers to set the compare value.
4. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt are generated for both input capture and reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting TICONFIG field of the TxCTL1 Register.
5. Configure the associated GPIO port pin for the Timer Input alternate function.
6. Write to the Timer Control Register to enable the timer.

causes the value in TxL to be stored in a temporary holding register. A read from TxL always returns this temporary register when the timers are enabled. When the timer is disabled, reads from the TxL reads the register directly.

Writing to the Timer High and Low Byte registers while the timer is enabled is not recommended. There are no temporary holding registers available for write operations, so simultaneous 16-bit writes are not possible. If either the Timer High or Low Byte registers are written during counting, the 8-bit written value is placed in the counter (High or Low Byte) at the next clock edge. The counter continues counting from the new value.

Table 51. Timer 0–1 High Byte Register (TxH)

Bit	7	6	5	4	3	2	1	0
Field	TH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F00H, F08H							

Table 52. Timer 0–1 Low Byte Register (TxL)

Bit	7	6	5	4	3	2	1	0
Field	TL							
RESET	0	0	0	0	0	0	0	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F01H, F09H							

Bit	Description
[7:0]	Timer High and Low Bytes
TH, TL	These 2 bytes, {TH[7:0], TL[7:0]}, contain the current 16-bit timer count value.

Timer Reload High and Low Byte Registers

The Timer 0–1 Reload High and Low Byte (TxRH and TxRL) registers (Table 53 and Table 54) store a 16-bit reload value, {TRH[7:0], TRL[7:0]}. Values written to the Timer Reload High Byte register are stored in a temporary holding register. When a write to the Timer Reload Low Byte register occurs, the temporary holding register value is written to the Timer High Byte register. This operation allows simultaneous updates of the 16-bit Timer reload value. In COMPARE Mode, the Timer Reload High and Low Byte registers store the 16-bit compare value.

- CEN resets to 0 to indicate the conversion is complete
6. If the ADC remains idle for 160 consecutive system clock cycles, it is automatically powered-down.

Continuous Conversion

When configured for continuous conversion, the ADC continuously performs an analog-to-digital conversion on the selected analog input. Each new data value over-writes the previous value stored in the ADC Data registers. An interrupt is generated after each conversion.

! **Caution:** In CONTINUOUS Mode, ADC updates are limited by the input signal bandwidth of the ADC and the latency of the ADC and its digital filter. Step changes at the input are not detected at the next output from the ADC. The response of the ADC (in all modes) is limited by the input signal bandwidth and the latency.

Observe the following steps for setting up the ADC and initiating continuous conversion:

1. Enable the acceptable analog input by configuring the general-purpose I/O pins for alternate function. This action disables the digital input and output driver.
2. Write the ADC Control/Status Register 1 to configure the ADC:
 - Write the REFSELH bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELH bit is contained in the ADC Control/Status Register 1.
3. Write to the ADC Control Register 0 to configure the ADC for continuous conversion. The bit fields in the ADC Control Register can be written simultaneously:
 - Write to the ANAIN[3:0] field to select from the available analog input sources (different input pins available depending on the device).
 - Set CONT to 1 to select continuous conversion.
 - If the internal VREF must be output to a pin, set the REFEXT bit to 1. The internal voltage reference must be enabled in this case.
 - Write the REFSELL bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELL bit is contained in ADC Control Register 0.
 - Set CEN to 1 to start the conversions.

ADC Data Low Bits Register

The ADC Data Low Byte register contains the lower bits of the ADC output as well as an overflow status bit. The output is a 11-bit two's complement value. During a single-shot conversion, this value is invalid. Access to the ADC Data Low Byte register is read-only. Reading the ADC Data High Byte register latches data in the ADC Low Bits Register.

Table 77. ADC Data Low Bits Register (ADCD_L)

Bit	7	6	5	4	3	2	1	0
Field	ADCDL			Reserved				OVF
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	F73H							

Bit	Description
[7:5] ADCDL	ADC Data Low Bits These bits are the least significant three bits of the 11-bits of the ADC output. These bits are undefined after a Reset.
[4:1]	Reserved These bits are reserved and are undefined when read.
[0] OVF	Overflow Status 0 = An overflow did not occur in the digital filter for the current sample. 1 = An overflow did occur in the digital filter for the current sample.

Flash Memory

The products in Z8 Encore! XP F0823 Series features either 8KB (8192), 4KB (4096), 2KB (2048) or 1KB (1024) of nonvolatile Flash memory with read/write/erase capability. Flash Memory can be programmed and erased in-circuit by either user code or through the On-Chip Debugger.

The Flash Memory array is arranged in pages with 512 bytes per page. The 512-byte page is the minimum Flash block size that can be erased. Each page is divided into 8 rows of 64 bytes.

For program/data protection, the Flash memory is also divided into sectors. In the Z8 Encore! XP F0823 Series, these sectors are either 1024 bytes (in the 8KB devices) or 512 bytes in size (all other memory sizes); each sector maps to a page. Page and sector sizes are not generally equal.

The first two bytes of the Flash program memory are used as Flash Option bits. For more information about their operation, see the [Flash Option Bits](#) chapter on page 146.

Table 79 describes the Flash memory configuration for each device in the Z8 Encore! XP F0823 Series. Figure 20 displays the Flash memory arrangement.

Table 79. Z8 Encore! XP F0823 Series Flash Memory Configurations

Part Number	Flash Size KB (Bytes)	Flash Pages	Program Memory Addresses	Flash Sector Size (bytes)
Z8F08x3	8 (8192)	16	0000H–1FFFH	1024
Z8F04x3	4 (4096)	8	0000H–0FFFH	512
Z8F02x3	2 (2048)	4	0000H–07FFH	512
Z8F01x3	1 (1024)	2	0000H–03FFH	512

Table 80. Flash Code Protection Using the Flash Option Bits

FWP	Flash Code Protection Description
0	Programming and erasing disabled for all of Flash Program Memory. In user code programming, Page Erase, and Mass Erase are all disabled. Mass Erase is available through the On-Chip Debugger.
1	Programming, Page Erase, and Mass Erase are enabled for all of Flash Program Memory.

Flash Code Protection Using the Flash Controller

At Reset, the Flash Controller locks to prevent accidental program or erasure of the Flash memory. To program or erase the Flash memory, first write the Page Select Register with the target page. Unlock the Flash Controller by making two consecutive writes to the Flash Control Register with the values 73H and 8CH, sequentially. The Page Select Register must be rewritten with the same page previously stored there. If the two Page Select writes do not match, the controller reverts to a locked state. If the two writes match, the selected page becomes active. For more details, see Figure 21.

After unlocking a specific page, you can enable either Page Program or Erase. Writing the value 95H causes a Page Erase only if the active page resides in a sector that is not protected. Any other value written to the Flash Control Register locks the Flash Controller. Mass Erase is not allowed in the user code but only in through the Debug Port.

After unlocking a specific page, you can also write to any byte on that page. After a byte is written, the page remains unlocked, allowing for subsequent writes to other bytes on the same page. Further writes to the Flash Control Register cause the active page to revert to a locked state.

Sector-Based Flash Protection

The final protection mechanism is implemented on a per-sector basis. The Flash memories of Z8 Encore! XP devices are divided into maximum number of 8 sectors. A sector is 1/8 of the total Flash memory size unless this value is smaller than the page size – in which case, the sector and page sizes are equal. On Z8 Encore! F0823 Series devices, the sector size is varied according to the Flash memory configuration shown in [Table 79](#) on page 134.

The Flash Sector Protect Register can be configured to prevent sectors from being programmed or erased. After a sector is protected, it cannot be unprotected by user code. The Flash Sector Protect Register is cleared after reset, and any previously-written protection values are lost. User code must write this register in their initialization routine if they prefer to enable sector protection.

The Flash Sector Protect Register shares its Register File address with the Page Select Register. The Flash Sector Protect Register is accessed by writing the Flash Control Register with 5EH. After the Flash Sector Protect Register is selected, it can be accessed at the Page Select Register address. When user code writes the Flash Sector Protect Register,

These serial numbers are stored in the Flash information page (for more details, see the [Reading the Flash Information Page](#) section on page 148 and the [Serialization Data](#) section on page 154) and are unaffected by mass erasure of the device’s Flash memory.

Randomized Lot Identification Bits

As an optional feature, Zilog is able to provide a factory-programmed random lot identifier. With this feature, all devices in a given production lot are programmed with the same random number. This random number is uniquely regenerated for each successive production lot and is not likely to be repeated.

The randomized lot identifier is a 32-byte binary value, stored in the flash information page (for more details, see the [Reading the Flash Information Page](#) section on page 148 and the [Randomized Lot Identifier](#) section on page 154) and is unaffected by mass erasure of the device’s flash memory.

Reading the Flash Information Page

The following code example shows how to read data from the Flash Information Area.

```

; get value at info address 60 (FE60h)
ldx FPS, #80 ; enable access to flash info page
ld R0, #FE
ld R1, #60
ldc R2, @RR0 ; R2 now contains the calibration value
    
```

Flash Option Bit Control Register Definitions

This section briefly describes the features of the Trim Bit Address and Data registers.

Trim Bit Address Register

The Trim Bit Address (TRMADR) Register contains the target address for an access to the trim option bits.

Table 87. Trim Bit Address Register (TRMADR)

Bit	7	6	5	4	3	2	1	0
Field	TRMADR: Trim Bit Address (00H to 1FH)							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF6H							

- If the PA2/ $\overline{\text{RESET}}$ pin is held Low while a 32-bit key sequence is issued to the PA0/DBG pin, the DBG feature is unlocked. After releasing PA2/ $\overline{\text{RESET}}$, it is pulled high. At this point, the PA0/DBG pin can be used to autobaud and cause the device to enter DEBUG Mode. For more details, see the OCD Unlock Sequence (8-Pin Devices Only) section on page 161.

Exiting DEBUG Mode

The device exits DEBUG Mode following any of these operations:

- Clearing the DBGMODE bit in the OCD Control Register to 0
- Power-On Reset
- Voltage Brown-Out reset
- Watchdog Timer reset
- Asserting the $\overline{\text{RESET}}$ pin Low to initiate a Reset
- Driving the DBG pin Low while the device is in STOP Mode initiates a system reset

OCD Data Format

The OCD interface uses the asynchronous data format defined for RS-232. Each character is transmitted as 1 Start bit, 8 data bits (least-significant bit first), and 1 Stop bit as displayed in Figure 25.

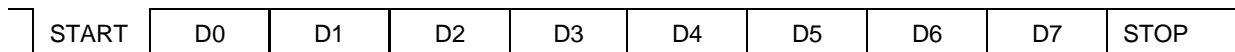


Figure 25. OCD Data Format

-
- **Note:** When responding to a request for data, the OCD may commence transmitting immediately after receiving the stop bit of an incoming frame. Therefore, when sending the stop bit, the host must not actively drive the DBG pin High for more than 0.5 bit times. Zilog recommends that, if possible, the host drives the DBG pin using an open-drain output.
-

OCD Autobaud Detector/Generator

To run over a range of baud rates (data bits per second) with various system clock frequencies, the OCD contains an auto-baud detector/generator. After a reset, the OCD is idle until it receives data. The OCD requires that the first character sent from the host is the character 80H. The character 80H has eight continuous bits Low (one Start bit plus 7 data

Electrical Characteristics

The data in this chapter represents all known data prior to qualification and characterization of the F0823 Series of products, and is therefore subject to change. Additional electrical characteristics may be found in the individual chapters of this document.

Absolute Maximum Ratings

Stresses greater than those listed in Table 120 may cause permanent damage to the device. These ratings are stress ratings only. Operation of the device at any condition outside those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For improved reliability, tie unused inputs to one of the supply voltages (V_{DD} or V_{SS}).

Table 120. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	+105	°C	
Storage temperature	-65	+150	°C	
Voltage on any pin with respect to V_{SS}	-0.3	+5.5	V	1
	-0.3	+3.9	V	2
Voltage on V_{DD} pin with respect to V_{SS}	-0.3	+3.6	V	
Maximum current on input and/or inactive output pin	-5	+5	μ A	
Maximum output current from active output pin	-25	+25	mA	
8-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		220	mW	
Maximum current into V_{DD} or out of V_{SS}		60	mA	
20-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		430	mW	
Maximum current into V_{DD} or out of V_{SS}		120	mA	
28-pin Packages Maximum Ratings at 0°C to 70°C				
Total power dissipation		450	mW	
Maximum current into V_{DD} or out of V_{SS}		125	mA	

Notes: Operating temperature is specified in DC Characteristics.

1. This voltage applies to all pins except the following: V_{DD} , AV_{DD} , pins supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1). On the 8-pin packages, this applies to all pins but V_{DD} .
2. This voltage applies to pins on the 20/28 pin packages supporting analog input (Port B[5:0], Port C[2:0]) and pins supporting the crystal oscillator (PA0 and PA1).

available to the eZ8 CPU on the second rising clock edge following the change of the port value.

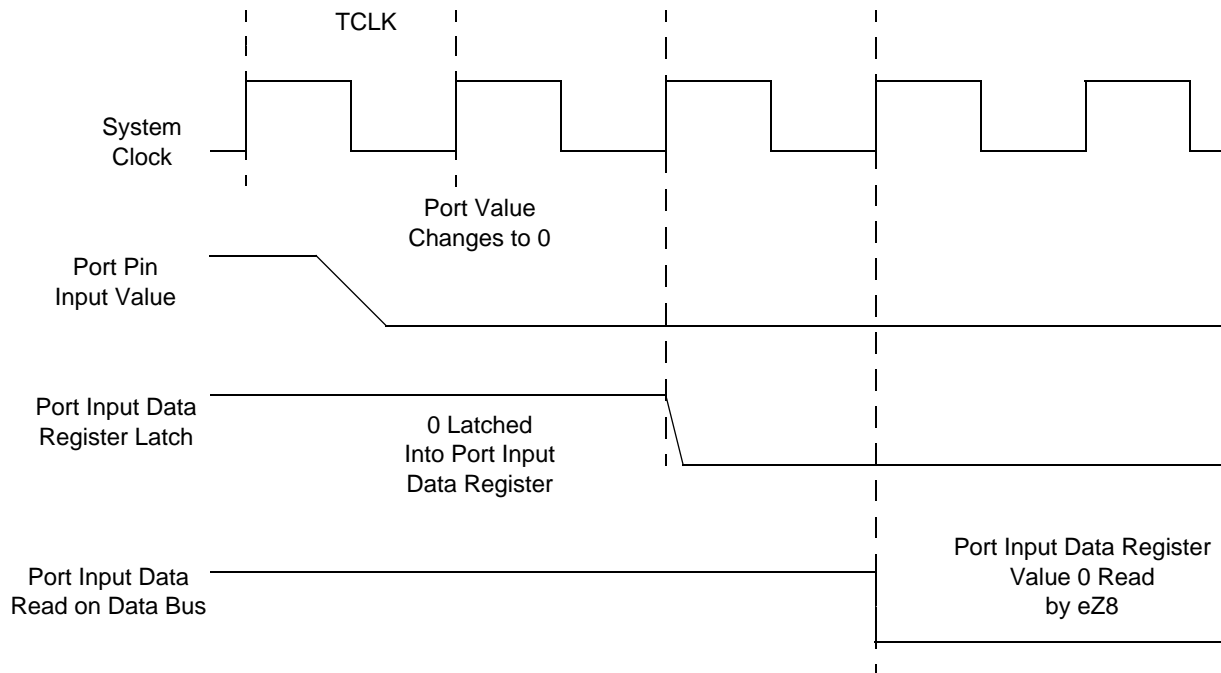


Figure 29. Port Input Sample Timing

Table 130. GPIO Port Input Timing

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
T _{S_PORT}	Port Input Transition to X _{IN} Rise Setup Time (Not pictured)	5	–
T _{H_PORT}	X _{IN} Rise to Port Input Transition Hold Time (Not pictured)	0	–
T _{SMR}	GPIO Port Pin Pulse Width to ensure Stop Mode Recovery (for GPIO Port Pins enabled as SMR sources)	1 μs	

On-Chip Debugger Timing

Figure 31 and Table 132 provide timing information for the DBG pin. The DBG pin timing specifications assume a 4 ns maximum rise and fall time.

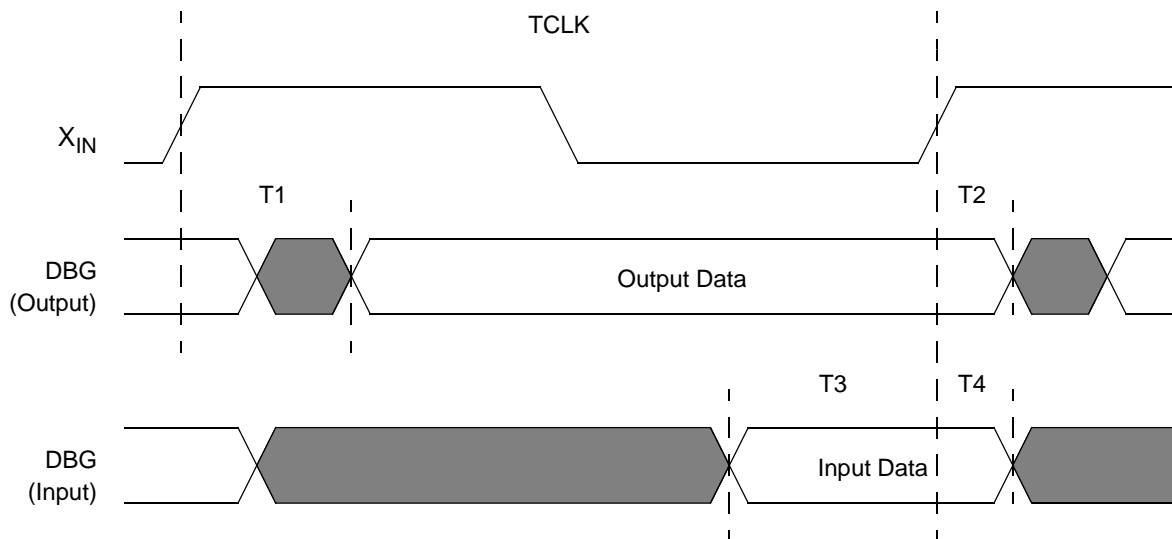


Figure 31. On-Chip Debugger Timing

Table 132. On-Chip Debugger Timing

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
DBG			
T ₁	X _{IN} Rise to DBG Valid Delay	–	15
T ₂	X _{IN} Rise to DBG Output Hold Time	2	–
T ₃	DBG to X _{IN} Rise Input Setup Time	5	–
T ₄	DBG to X _{IN} Rise Input Hold Time	5	–

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